



Connectors > Socket Connectors > IC & Component Socket Accessories > IC Socket Hardware > LGA 2011 Hardware: ILM Assembly



Compatible With IC Socket Type: LGA 2011

Card & Socket Accessory Type: Backplate

Operating Temperature Range: -25 – 100 °C [-13 – 212 °F]

[All LGA 2011 Hardware: ILM Assembly \(5\)](#)

Features

Product Type Features

Card & Socket Accessory Type	Backplate
Product Type	Accessory

Body Features

Spring Plate Assembly Material	Stainless Steel
Top Support Plate Material	Stainless Steel
Backplate Material	Steel
Insulator Material	Polycarbonate Film Plus Acrylic Adhesive Layer
Plating Material	Nickel

Contact Features

Compatible With IC Socket Type	LGA 2011
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Usage Conditions

Operating Temperature Range	-25 – 100 °C[-13 – 212 °F]
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Packaging Features

Packaging Method	Bag/Box
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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) ‘Guidance on requirements for substances in articles’ posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts

TE Part # CAT-L59017-A68
[LGA 2011 SOCKETS](#)

TE Part # CAT-L59017-A68H
[LGA 2011 Hardware: ILM Assembly](#)

Customers Also Bought



TE Part #1554653-1
LGA 2011 SOCKETS

TE Part #1-5103308-3
A/L LOW PRO HDR 24P VERT BLACK

TE Part #1871058-3
PCI EXPRESS CONN. EON TYPE, 98

TE Part #1-5316318-1
.6FHR12H,160,S,GIG,08/Sn,HT,SEYes

TE Part #1-5316318-0
.6FHR12H,140,S,GIG,08/Sn,HT,SEYes

TE Part #9-2176378-7
RQ 0805 100R 0.1% 10PPM 5K RL

TE Part #1735164-1
PT30 XFP Connectors

TE Part #1-1932680-1
DDR3 DIMM SOCKETS

TE Part #1-1734774-6
PCI EXP 3.1L 164 POS BLK 15u"

TE Part #1939738-1
ILM COVER ASSY, LGA1366

Documents

Product Drawings
BP ASSY, LGA2011

English

CAD Files
3D PDF

3D

Customer View Model
ENG_CVM_CVM_2134440-1_B.2d_dxf.zip

English

Customer View Model
ENG_CVM_CVM_2134440-1_B.3d_igs.zip

English

Customer View Model
ENG_CVM_CVM_2134440-1_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages



6-1773461-9_LGA_2011_SOCKET

English

Product Specifications

Application Specification

English

Product Environmental Compliance

MD_2134440-1_080220181226_dmtec

English

MD_2134440-1_080220181226_dmtec

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